

PATENT ASSIGNMENT

Electronic Version v1.1
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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT
CONVEYING PARTY DATA	
Name	Execution Date
Jack Alan Strahm Jr.	08/12/2010
RECEIVING PARTY DATA	
Name:	Honda Motor Co., Ltd.
Street Address:	No. 1-1, Minami-Aoyama
Internal Address:	2-chome, Minato-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	107-8556
PROPERTY NUMBERS Total: 1	
Property Type	Number
Application Number:	12875164
CORRESPONDENCE DATA	
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<i>Correspondence will be sent via US Mail when the fax attempt is unsuccessful.</i>	
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Correspondent Name:	Timothy D. Bennett
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ATTORNEY DOCKET NUMBER:	30515.50196
NAME OF SUBMITTER:	Timothy D. Bennett
Total Attachments: 1 source=Executed_Assignment_for_Jack_Alان_Strahm_Jr_as_Filed#page1.tif	

CH \$40.00 12875164

Docket No.: 30515.50196
Application No.: 12/875,164
Filed Date: September 3, 2010

ASSIGNMENT
Mansville,

WHEREAS, I, **Jack Alan Strahm, Jr.** of **Mansville, Ohio**, (the Undersigned Inventor) have invented certain improvements related to a **BOOSTER SEAT ASSEMBLY** (the Invention) and, the Invention is at least partially described in US patent application, serial number 12/875,164 filed on the 3rd day of September, 2010 (the Application), and being the owner of the right, title and interest in and to the Invention and the Application as the inventor, and having full right to convey my entire interest both legal and equitable herein assigned; and

WHEREAS, **Honda Motor Co., Ltd.**, of No. 1-1, Minami-Aoyama 2-chome, Minato-ku, Tokyo 107-8556, JAPAN, a corporation of JAPAN (assignee) is desirous of acquiring the entire right, title and interest in and to the Invention and the Application and any and all patents to be obtained therefore, all as hereinafter set forth:

NOW, THEREFORE, in consideration of good and valuable consideration received by the Undersigned Inventor, the Undersigned Inventor does hereby sell, assign, transfer and set over unto said assignee, its successors and assigns, my entire right, title and interest in and to the Invention in any form or embodiment thereof, and in and to the Application including in and to any application filed in this or any foreign country based thereon, including the right to file said foreign applications under the provisions of the International Convention; also my entire right, title and interest in and to any and all patents or reissues or extensions thereof to be obtained in this or any foreign country upon the Invention and any divisionals, continuations, continuations-in-part or substitute applications which may be filed upon the Invention in this or any foreign country; and the Undersigned Inventor hereby authorizes and requests the issuing authority to issue any and all patents on the Invention to said assignee or its successors and assigns.

The Undersigned Inventor further agrees to execute all divisional, continuing, substitute, improvement, extension, reissue and other patent applications in this or any foreign country relating to the Invention or the Application and to sign all other lawful papers and to perform all other lawful acts without further consideration, but without expense to myself, which the assignee may deem necessary or desirable to make this Assignment fully effective including by way of example, but not of limitation, the following acts:

- (1) Prompt execution of all lawful oaths, affidavits and/or supplemental oaths required or deemed advisable by the assignee to further the prosecution of any application or applications for letters patent relating to the subject matter of this Assignment;
- (2) To co-operate to the best of my ability in the execution of all lawful documents, the production of evidence, and the giving of testimony in interference, opposition, nullification or infringement proceedings involving the Invention, the Application or any applications or patents upon the Invention or the Application.

The Undersigned Inventor hereby authorizes said assignee to insert into this Assignment the serial number and filing date of the Application if it is not currently known.

The Undersigned Inventor, intending to be legally bound, has signed this Assignment on the date written by the Undersigned Inventor's signature below.

Jack Alan Strahm, Jr., 08, 12, 2010
Date

State of OHIO }
City of Raymond } SS:

On this 12 day of August, 2010, before me personally appeared **Jack Alan Strahm, Jr.**, personally known, and known to me to be the person(s) who signed the foregoing assignment, and acknowledge the signing of same as his free act and deed.

Lisa A. Howard, 8/12, 2010
Notary Public (Print Name) Signature Date

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